

CS - F241
MICROPROCESSORS & INTERFACING

Design Assignment:

H_{FE} TESTER FOR NPN TRANSISTORS



TEAM

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Problem -17

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Problem Statement:

Design a microprocessor transistor h_{FE} tester. The system has to display the h_{FE} value of NPN transistors. The transistor under test (TUT) is to be inserted in the socket, and its base is energized with a current from a device DI.

The current I produced by the device DI, can be controlled by supplying it with a DC voltage V . The relationship is as follows:

$$[I = V * 10^{-4} \text{ A}]$$

The emitter of the transistor is grounded, and the collector is connected to a 2.2K resistor, whose other end is connected to the +5V supply. The Voltage drop across a 2.2K resistor is measured and this is related to the h_{FE} by the following relation:

$$[H_{FE} * I * 2200 = \text{Voltage Drop}]$$

The h_{FE} value should be displayed on a LCD display. If the h_{FE} value is less than 50, an alarm should be sounded 2 seconds.

Specification:

- User inserts the transistor into a socket and turns on a switch to indicate a transistor has been connected.
- “DI” is supplied with a voltage of 0.1V from the microprocessor using resistor-relay combination.

- The base is energized with the corresponding current gain given by the relation: $[I = V * 10^{-4}]$
- Depending upon the input current and the hFE value of the transistor, the collector current and hence the voltage drop across the resistor varies.
- This voltage drop is fed to ADC 0804 and the hFE is calculated using the relation: $[H_{FE} * I * 2200 = \text{Voltage Drop}]$

- The h_{FE} value is displayed on the LCD.
[If it is less than 50, the alarm is activated for 2 seconds.]

"DI" device circuit:

["DI" is a VCCS (Voltage Controlled Current Source) with the given transconductance of 100 Micro Ω .]

- "DI" is connected to a resistor circuit. There are two resistors of resistances $9.8K\Omega$ and 200Ω connected to a 5V source.
- One end of each resistor is connected to a "DI" device through a relay circuit switch.
- Each of these switches are connected to the microprocessor(8086) through an 8255. When a switch is closed (i.e., logic 1 at terminals of coil) the voltage at that end of the resistor (where the switch is connected) is provided to the DI device.

Assumptions:

- The values of H_{FE} are integral.
[The loss of resolution is insignificant for the expected values of H_{FE}]
- Voltage supplied to the device "**DI**" is 0.1 V.
- This value of voltage won't drive the transistor to saturation.
- DI draws very little current (negligible) owing to its very high impedance.
- The value of H_{FE} won't exceed 256.

Components Used:

<u>COMPONENT</u>	<u>DESCRIPTION</u>	<u>NUMBER</u>
Intel 8086	Microprocessor	1
82C55	Programmable Peripheral Interface	2
ADC0804	Analog to Digital Converter	1
6116	2K * 8-bit SRAM	2
2732	4K * 8-bit ROM	2
74LS244	4-bit Buffer	1
74LS373	8-bit Latch	4
74LS245	8-bit Buffer	4
2N2369	NPN Transistor	1
-	NOT gate	8
LM020L	LCD	1
ACS755XCB-130	Voltage Sensor	1
8253A	Programmable interval timer	1

Memory Organization:

Two SRAM chips and two ROM chips are used. Both SRAM and ROM are organized into even and odd banks to facilitate both byte size and word size data transfer. The circuitry for chip selection has been shown on the drawing sheet.

STATIC RANDOM ACCESS MEMORY –SRAM

- Starting address: 08000H
- Ending address: 08FFFH

READ ONLY MEMORY –ROM

- Starting address: 00000H
- Ending address: 01FFFFH

The code resides in the ROM and begins at address **00000H**.

(The address loaded as soon as the system is switched on is FFFF0H)

CHIP	A19	A18	A17	A16	A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0
EPROM																				
2732																				
From																				
00000h	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
To																				
01FFFh	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1
SRAM																				
6116																				

From																
08000H	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
To																
08FFFh	0	0	0	0	1	0	0	0	1	1	1	1	1	1	1	1

8255 (1)

Port Type	Port Address	Type
A	00h	Output
B	02h	Output
C (lower)	04h	Output
C (upper)	04h	Input
Control register	06h	

8255 (2)

Port Type	Port Address	Type
A	10h	Output
B	12h	Input
C (lower)	14h	Output
C (upper)	14h	Input
Control register	16h	

I/O Organization:

Both used in i/o mode.

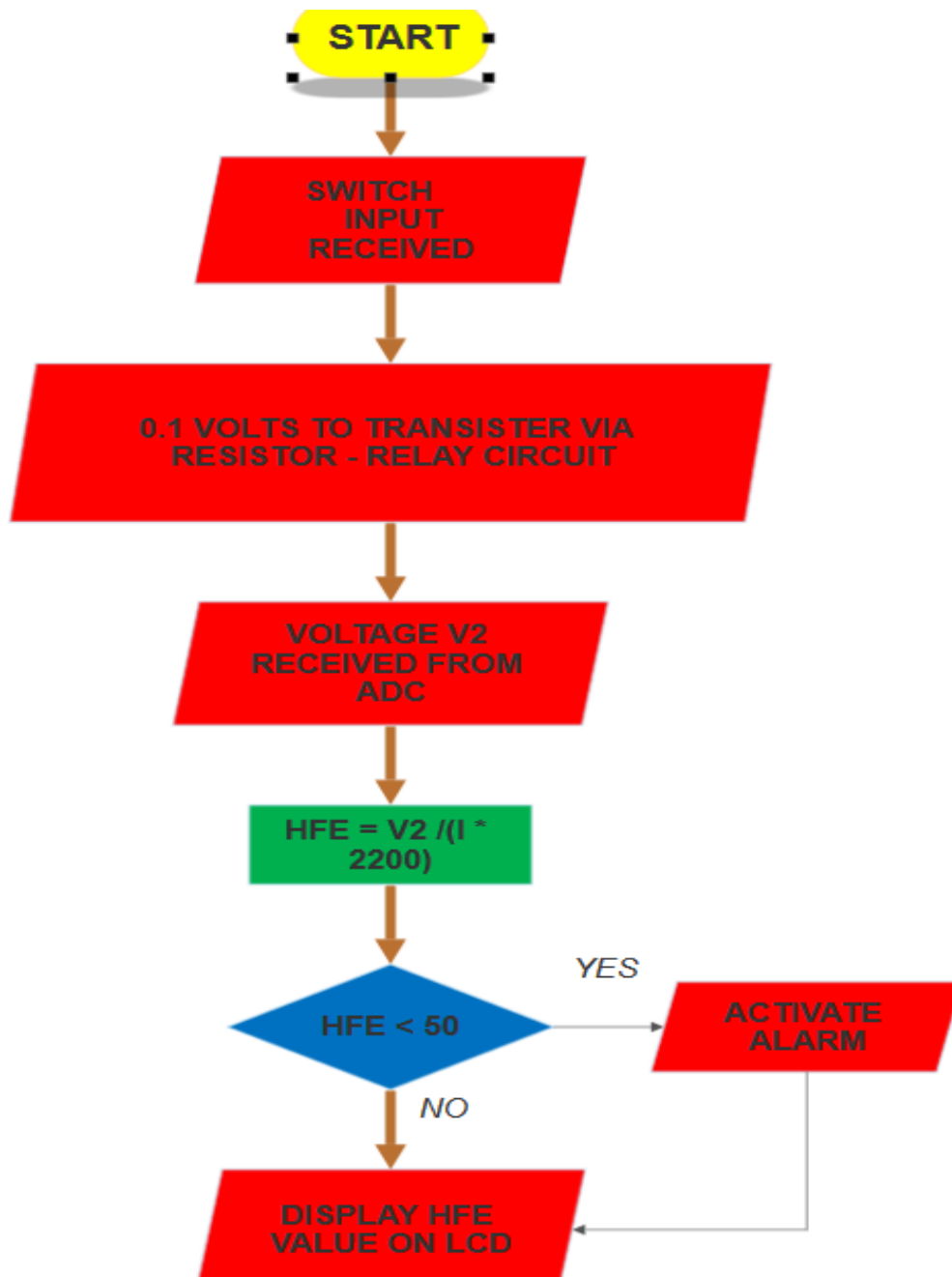
Control Word for 8255 (1): 10001000

- Mode for port A = simple i/o (i.e. 00)
- Port A is used for generating control signal of LCD
- Port B is used for giving input to the LCD
- Mode for group B = simple i/o (i.e. 0)
- PC0 – PC3 used as output to LED.
- PC4 – PC7 used as input from the switch.

Control Word for 8255 (2): 10001010

- Mode for port A = simple i/o (i.e. 00)
- Port A is used for giving input to DI device
- Port B is used for taking input from ADC
- Mode for group B = simple i/o (i.e. 0)
- PC0 – PC3 used as output (PC2 is used for controlling the alarm)
- PC4 – PC7 used as input (PC5 – INTR of ADC)

Flow Chart:



x86 Code:

make bin

#LOAD_SEGMENT=FFFFh#

#LOAD_OFFSET=0000h#

#CS=0000h#

#IP=0000h#

#DS=0000h#

#ES=0000h#

#SS=0000h#

#SP=FFFEh#

#AX=0000h#

#BX=0000h#

#CX=0000h#

#DX=0000h#

#SI=0000h#

#DI=0000h#

#BP=0000h#

.MODEL TINY

.DATA

;8253 USED TO GENERATE CLOCK FOR ADC

CNT0 EQU 20H

CREG EQU 26H

;8255(1) INITIALISE

PORT1A EQU 00H ;CONTROLLING THE LCD

PORT1B EQU 02H ;INPUT TO LCD

PORT1C EQU 04H ;UPPER - ROW

_____ ;LOWER - COLUMN

CREG1 EQU 06H

;8255(2) USED FOR ADC, ALARM AND SWITCH

PORT2A EQU 10H ;INPUT TO DI DEVICE

PORT2B EQU 12H ;ADC

PORT2C EQU 14H ;PC1 - SOC OF ADC

;PC2 - ALARM

;PC3 - ADDC OF ADC (USED FOR SELECTING THE ;FIRST INPUT CHANNEL OF ADC)

;PC5 - EOC OF ADC
CREG2 EQU 16H

DAT2 DB 3 DUP(" ");
T DB 30H,31H
.CODE
.STARTUP

MOV AL,00010110B ;INITIALIZING 8253
OUT CREG,AL
MOV AL,5
OUT CNT0,AL

MOV AL,10001000B ;INITIALIZING 8255(1)
OUT CREG1,AL
CALL DELAY 2MS

MOV AL,10001010B ;INITIALIZING 8255(2)
OUT CREG2,AL
CALL DELAY 2MS

KX1: IN AL,PORT1C
AND AL,80H
CMP AL,80H
JNZ KX1

MOV AL,20H ;input to DI device
OUT PORT2A,AL

MOV AL,06H;GIVE ADC transfer 0
OUT CREG2,AL

MOV AL,00H;GIVE ALE
OUT CREG2,AL

MOV AL,02H;GIVE SOC
OUT CREG2,AL

MOV AL,01H ; GIVE ALE
OUT CREG2,AL

MOV AL,03H ;GIVE SOC
OUT CREG2,AL

MOV AL,02H;GIVE SOC
OUT CREG2,AL

MOV AL,00H;GIVE ALE
OUT CREG2,AL

LOOP2:
IN AL,PORT2C
CALL DELAY 2MS
AND AL,20H ;CHECK FOR EOC
CMP AL,20H
JNZ LOOP2
CALL DELAY 2MS

MOV AL,10001010B ;INITIALIZING 8255(2)
OUT CREG2,AL
IN AL,PORT2B ;AL HAS THE VOLTAGE DROP ACROSS THE RESISTOR
NOT AL

CALL HFE
CALL FUNC
CALL ALARM

.EXIT

ALARM PROC NEAR
CMP AL,50
JNB Z2
MOV AL,05H
OUT CREG2,AL

CALL DELAY 2S

MOV AL,04H
OUT CREG2,AL
Z2:
MOV CX,10
Z3:
CALL DELAY 2S

LOOP Z3
CALL DELAY 2S
RET
ALARM ENDP

HFE PROC NEAR
MOV BL,2DH
MUL BL
MOV BL,033H
DIV BL
MOV AH,00H

RET
HFE ENDP

FUNC PROC NEAR
PUSH AX
MOV AL,38H
CALL COMNDWRT ; to enable led
CALL DELAY
CALL DELAY
CALL DELAY
MOV AL,0EH
CALL COMNDWRT

MOV AL, 01 ;CLEAR LCD
CALL COMNDWRT
CALL DELAY
CALL DELAY

POP AX
PUSH AX
LEA DI,DAT2
MOV BX,100D
MOV DX,0
DIV BX
ADD AL,30H
CALL DATWRIT ;ISSUE IT TO LCD
CALL DELAY
CALL DELAY
MOV AX,DX
MOV BX,10D

MOV DX,0
DIV BX
ADD AL,30H
CALL DATWRIT
CALL DELAY
CALL DELAY
MOV AX,DX
MOV DX,0
ADD AL,30H
CALL DATWRIT
CALL DELAY
CALL DELAY
POP AX

RET
FUNC ENDP

COMNDWRT PROC ;THIS PROCEDURE WRITES COMMANDS TO LCD
OUT PORT1B, AL ;SEND THE CODE TO PORT A , to send the data to lcd
MOV AL, 00000100B ;RS=0,R/W=0,E=1 FOR H-TO-L PULSE
OUT PORT1A, AL ; to activate enable of LCD
NOP
NOP
MOV AL, 00000000B ;RS=0,R/W=0,E=0 FOR H-TO-L PULSE
OUT PORT1A, AL
RET
COMNDWRT ENDP

DATWRIT PROC NEAR
PUSH DX ;SAVE DX
MOV DX,PORT1B ;DX=PORT A ADDRESS
OUT DX, AL ;ISSUE THE CHAR TO LCD
MOV AL, 00000101B ;RS=1, R/W=0, E=1 FOR H-TO-L PULSE
MOV DX, PORT1A ;PORT B ADDRESS
OUT DX, AL ;MAKE ENABLE HIGH
MOV AL, 00000001B ;RS=1,R/W=0 AND E=0 FOR H-TO-L PULSE
OUT DX, AL
POP DX
RET
DATWRIT ENDP ;WRITING ON THE LCD ENDS

DELAY 2MS PROC NEAR
MOV CX,100

HER: NOP
LOOP HER
RET
DELAY 2MS ENDP

;DELAY IN THE CIRCUIT HERE THE DELAY OF 20 MILLISECOND IS PRODUCED

DELAY PROC
MOV CX, 1325 ;1325*15.085 USEC = 20 MSEC

W1:
 NOP
 NOP
 NOP
 NOP
 NOP

LOOP W1
RET
DELAY ENDP

DELAY 2S PROC
MOV CX, 33125D

W2:
 NOP
 NOP
 NOP
 NOP
 NOP

LOOP W2
 MOV CX, 33125D

W3:
 NOP
 NOP
 NOP
 NOP
 NOP

LOOP W3
 MOV CX, 33125D

W4:
 NOP
 NOP
 NOP
 NOP
 NOP

LOOP W4

